

## 6A High-Speed MOSFET Drivers

### Features

- Latch-Up Protected: will withstand >1.5A Reverse Output Current
- Logic Input will withstand Negative Swing Up to 5V
- ESD Protected: 4 kV
- Matched Rise and Fall Times:
  - 25 nsec (2500 pF load)
- High Peak Output Current: 6A Peak
- Wide Input Supply Voltage Operating Range:
  - 4.5V to 18V
- High Capacitive Load Drive Capability: 10,000 pF
- Short Delay Time: 55 nsec (typ.)
- Logic High Input, Any Voltage: 2.4V to  $V_{DD}$
- Low Supply Current With Logic '1' Input:
  - 450  $\mu$ A (typ.)
- Low Output Impedance: 2.5 $\Omega$
- Output Voltage Swing to Within 25 mV of Ground or  $V_{DD}$

### Applications

- Switch-Mode Power Supplies
- Motor Controls
- Pulse Transformer Driver
- Class D Switching Amplifiers

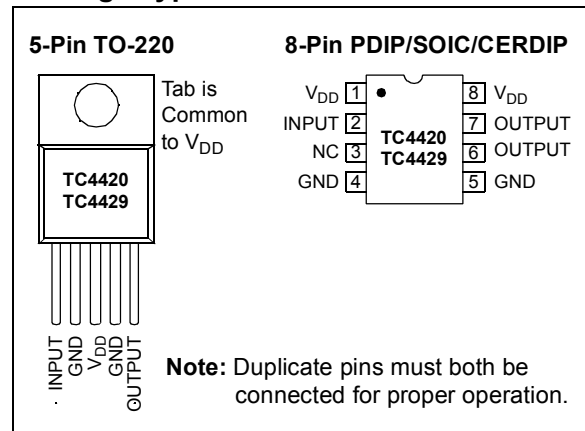
### General Description

The TC4420/TC4429 are 6A (peak), single output MOSFET drivers. The TC4429 is an inverting driver (pin-compatible with the TC429), while the TC4420 is a non-inverting driver. These drivers are fabricated in CMOS for lower power, more efficient operation versus bipolar drivers.

Both devices have TTL-compatible inputs, which can be driven as high as  $V_{DD} + 0.3V$  or as low as -5V without upset or damage to the device. This eliminates the need for external level-shifting circuitry and its associated cost and size. The output swing is rail-to-rail, ensuring better drive voltage margin, especially during power-up/power-down sequencing. Propagational delay time is only 55 nsec (typ.) and the output rise and fall times are only 25 nsec (typ.) into 2500 pF across the usable power supply range.

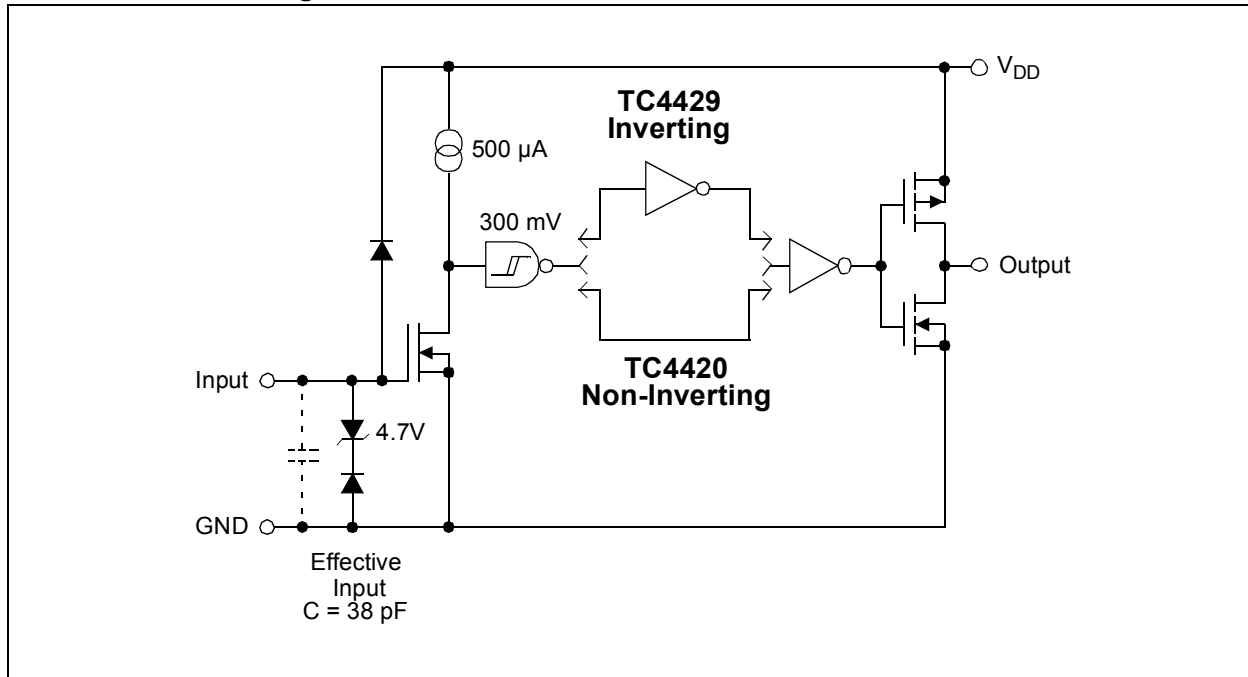
Unlike other drivers, the TC4420/TC4429 are virtually latch-up proof. They replace three or more discrete components, saving PCB area, parts and improving overall system reliability.

### Package Types:



# TC4420/TC4429

## Functional Block Diagram



## 1.0 ELECTRICAL CHARACTERISTICS

### Absolute Maximum Ratings†

Supply Voltage .....	+20V
Input Voltage .....	- 5V to $V_{DD} + 0.3V$
Input Current ( $V_{IN} > V_{DD}$ ).....	50 mA
Power Dissipation ( $T_A \leq 70^\circ C$ )	
PDIP .....	730 mW
SOIC.....	470 mW
CERDIP.....	800 mW
5-Pin TO-220.....	1.6W
Package Power Dissipation ( $T_A \leq 25^\circ C$ )	
5-Pin TO-220 (With Heatsink) .....	12.5W
Derating Factors (To Ambient)	
PDIP .....	8 mW/ $^\circ C$
SOIC.....	4 mW/ $^\circ C$
CERDIP.....	6.4 mW/ $^\circ C$
5-Pin TO-220.....	12 mW/ $^\circ C$
Thermal Impedances (To Case)	
5-Pin TO-220 $R_{\theta J-C}$ .....	10 $^\circ C/W$

† Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

## DC CHARACTERISTICS

Electrical Specifications: Unless otherwise noted, $T_A = +25^\circ C$ with $4.5V \leq V_{DD} \leq 18V$ .						
Parameters	Sym	Min	Typ	Max	Units	Conditions
<b>Input</b>						
Logic '1', High Input Voltage	$V_{IH}$	2.4	1.8	—	V	
Logic '0', Low Input Voltage	$V_{IL}$	—	1.3	0.8	V	
Input Voltage Range	$V_{IN}$	- 5	—	$V_{DD}+0.3$	V	
Input Current	$I_{IN}$	-10	—	+10	$\mu A$	$0V \leq V_{IN} \leq V_{DD}$
<b>Output</b>						
High Output Voltage	$V_{OH}$	$V_{DD} - 0.025$	—	—	V	DC TEST
Low Output Voltage	$V_{OL}$	—	—	0.025	V	DC TEST
Output Resistance, High	$R_{OH}$	—	2.1	2.8	$\Omega$	$I_{OUT} = 10 \text{ mA}, V_{DD} = 18V$
Output Resistance, Low	$R_{OL}$	—	1.5	2.5	$\Omega$	$I_{OUT} = 10 \text{ mA}, V_{DD} = 18V$
Peak Output Current	$I_{PK}$	—	6.0	—	A	$V_{DD} = 18V$
Latch-Up Protection Withstand Reverse Current	$I_{REV}$	—	> 1.5	—	A	Duty cycle $\leq 2\%$ , $t \leq 300 \mu\text{sec}$
<b>Switching Time (Note 1)</b>						
Rise Time	$t_R$	—	25	35	nsec.	Figure 4-1, $C_L = 2,500 \text{ pF}$
Fall Time	$t_F$	—	25	35	nsec.	Figure 4-1, $C_L = 2,500 \text{ pF}$
Delay Time	$t_{D1}$	—	55	75	nsec.	Figure 4-1
Delay Time	$t_{D2}$	—	55	75	nsec.	Figure 4-1
<b>Power Supply</b>						
Power Supply Current	$I_S$	—	0.45	1.5	mA	$V_{IN} = 3V$
		—	55	150	$\mu A$	$V_{IN} = 0V$
Operating Input Voltage	$V_{DD}$	4.5	—	18	V	

**Note 1:** Switching times ensured by design.

# TC4420/TC4429

## DC CHARACTERISTICS (OVER OPERATING TEMPERATURE RANGE)

Electrical Specifications: Unless otherwise noted, over operating temperature range with $4.5V \leq V_{DD} \leq 18V$ .						
Parameters	Sym	Min	Typ	Max	Units	Conditions
<b>Input</b>						
Logic '1', High Input Voltage	$V_{IH}$	2.4	—	—	V	
Logic '0', Low Input Voltage	$V_{IL}$	—	—	0.8	V	
Input Voltage Range	$V_{IN}$	-5	—	$V_{DD} + 0.3$	V	
Input Current	$I_{IN}$	-10	—	+10	$\mu A$	$0V \leq V_{IN} \leq V_{DD}$
<b>Output</b>						
High Output Voltage	$V_{OH}$	$V_{DD} - 0.025$	—	—	V	DC TEST
Low Output Voltage	$V_{OL}$	—	—	0.025	V	DC TEST
Output Resistance, High	$R_{OH}$	—	3	5	$\Omega$	$I_{OUT} = 10 \text{ mA}, V_{DD} = 18V$
Output Resistance, Low	$R_{OL}$	—	2.3	5	$\Omega$	$I_{OUT} = 10 \text{ mA}, V_{DD} = 18V$
<b>Switching Time (Note 1)</b>						
Rise Time	$t_R$	—	32	60	nsec.	Figure 4-1, $C_L = 2,500 \text{ pF}$
Fall Time	$t_F$	—	34	60	nsec.	Figure 4-1, $C_L = 2,500 \text{ pF}$
Delay Time	$t_{D1}$	—	50	100	nsec.	Figure 4-1
Delay Time	$t_{D2}$	—	65	100	nsec.	Figure 4-1
<b>Power Supply</b>						
Power Supply Current	$I_S$	—	0.45	3	$\mu A$	$V_{IN} = 3V$ $V_{IN} = 0V$
Operating Input Voltage	$V_{DD}$	4.5	—	18	V	

**Note 1:** Switching times ensured by design.

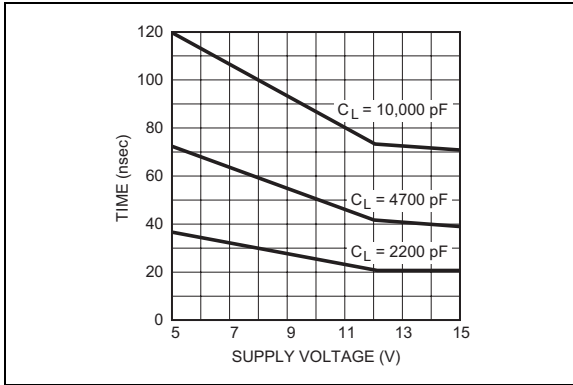
## TEMPERATURE CHARACTERISTICS

Electrical Specifications: Unless otherwise noted, all parameters apply with $4.5V \leq V_{DD} \leq 18V$ .						
Parameters	Sym	Min	Typ	Max	Units	Conditions
<b>Temperature Ranges</b>						
Specified Temperature Range (C)	$T_A$	0	—	+70	$^{\circ}C$	
Specified Temperature Range (I)	$T_A$	-25	—	+85	$^{\circ}C$	
Specified Temperature Range (E)	$T_A$	-40	—	+85	$^{\circ}C$	
Specified Temperature Range (M)	$T_A$	-55	—	+125	$^{\circ}C$	
Specified Temperature Range (V)	$T_A$	-40	—	+125	$^{\circ}C$	
Maximum Junction Temperature	$T_J$	—	—	+150	$^{\circ}C$	
Storage Temperature Range	$T_A$	-65	—	+150	$^{\circ}C$	
<b>Package Thermal Resistances</b>						
Thermal Resistance, 8L-PDIP	$\theta_{JA}$	—	125	—	$^{\circ}C/W$	
Thermal Resistance, 8L-SOIC	$\theta_{JA}$	—	155	—	$^{\circ}C/W$	
Thermal Resistance, 8L-CERDIP	$\theta_{JA}$	—	150	—	$^{\circ}C/W$	
Thermal Resistance, 5L-TO-220	$\theta_{JA}$	—	71	—	$^{\circ}C/W$	

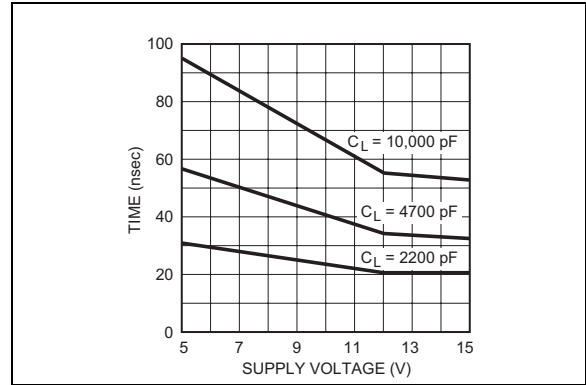
## 2.0 TYPICAL PERFORMANCE CURVES

**Note:** The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data presented may be outside the specified operating range (e.g., outside specified power supply range) and therefore outside the warranted range.

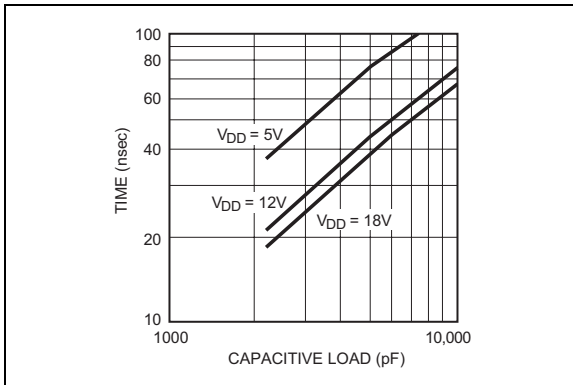
**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$  with  $4.5\text{V} \leq V_{DD} \leq 18\text{V}$ .



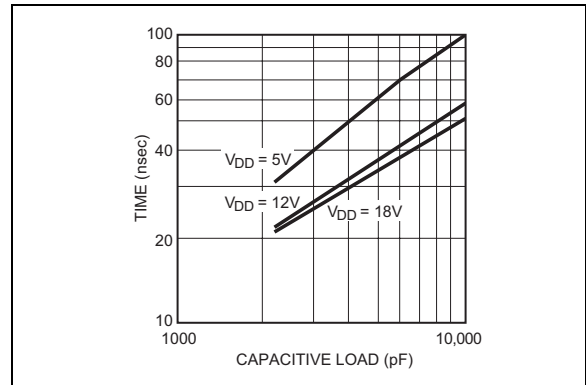
**FIGURE 2-1:** Rise Time vs. Supply Voltage.



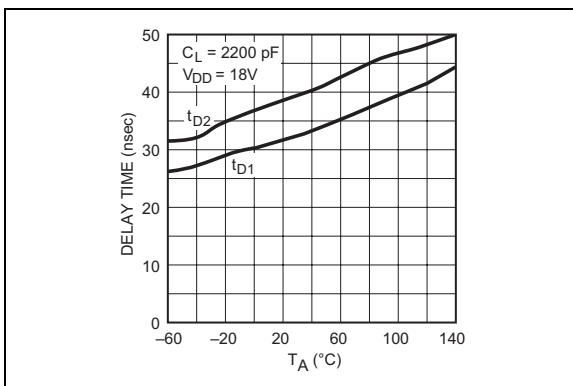
**FIGURE 2-4:** Fall Time vs. Supply Voltage.



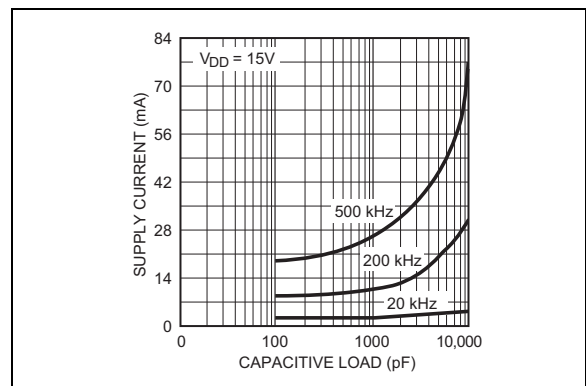
**FIGURE 2-2:** Rise Time vs. Capacitive Load.



**FIGURE 2-5:** Fall Time vs. Capacitive Load.



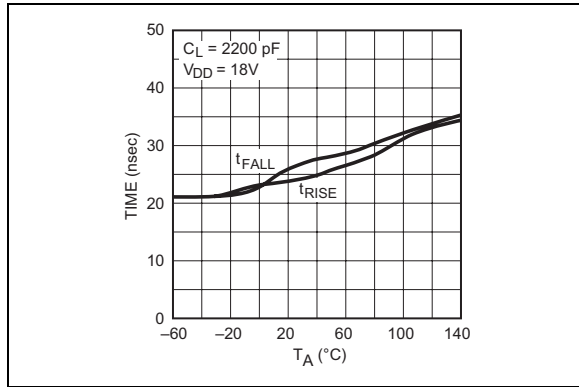
**FIGURE 2-3:** Propagation Delay Time vs. Temperature.



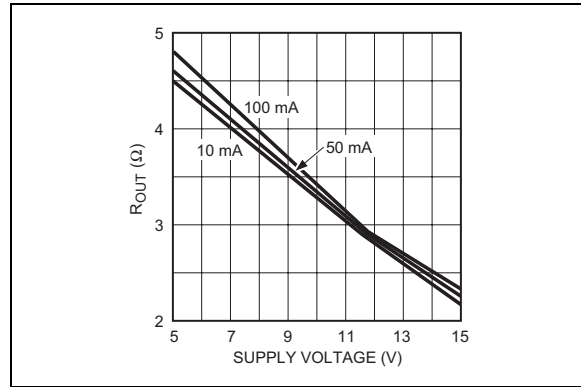
**FIGURE 2-6:** Supply Current vs. Capacitive Load.

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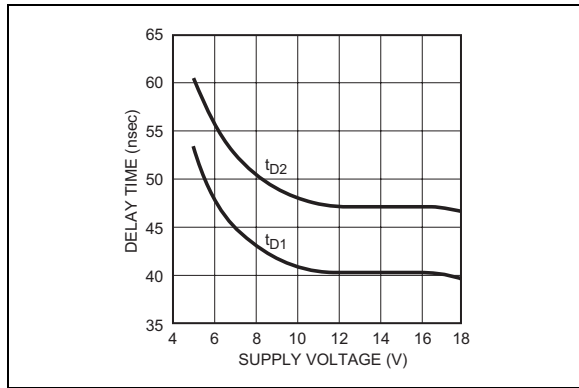
Note: Unless otherwise indicated,  $T_A = +25^\circ\text{C}$  with  $4.5\text{V} \leq V_{DD} \leq 18\text{V}$ .



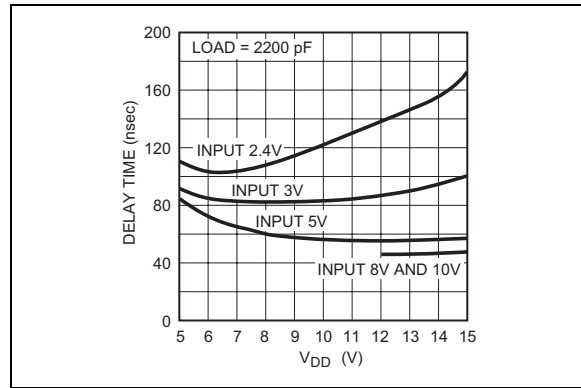
**FIGURE 2-7:** Rise and Fall Times vs. Temperature.



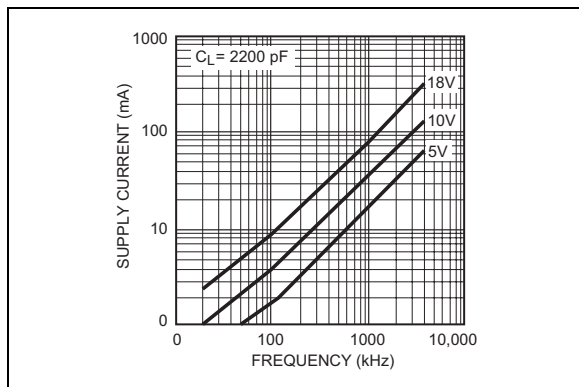
**FIGURE 2-10:** High-State Output Resistance vs Supply Voltage.



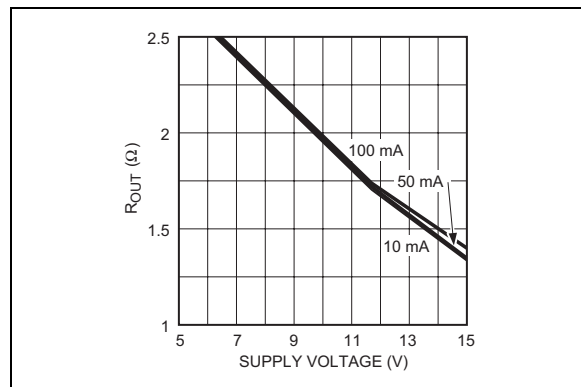
**FIGURE 2-8:** Propagation Delay Time vs. Supply Voltage.



**FIGURE 2-11:** Effect of Input Amplitude on Propagation Delay.

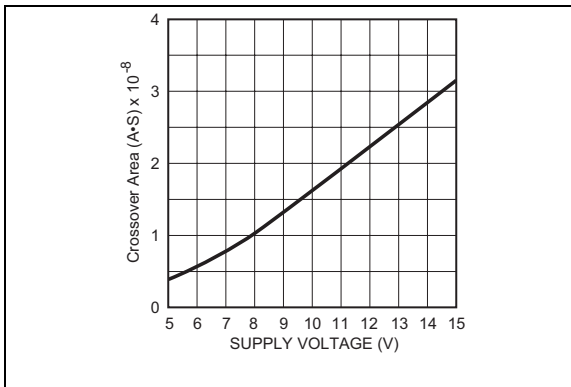


**FIGURE 2-9:** Supply Current vs. Frequency.



**FIGURE 2-12:** Low-State Output Resistance vs. Supply Voltage.

**Note:** Unless otherwise indicated,  $T_A = +25^\circ\text{C}$  with  $4.5\text{V} \leq V_{DD} \leq 18\text{V}$ .



**FIGURE 2-13:** Crossover Energy \*

\* The values on this graph represent the loss seen by the driver during one complete cycle. For a single transition, divide the value by 2.

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## 3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

**TABLE 3-1: PIN FUNCTION TABLE**

Pin No. (8-Pin PDIP, SOIC, CERDIP)	Pin No. (5-Pin TO-220)	Symbol	Description
1	—	$V_{DD}$	Supply input, 4.5V to 18V
2	1	INPUT	Control input, TTL/CMOS-compatible input
3	—	NC	No Connection
4	2	GND	Ground
5	4	GND	Ground
6	5	OUTPUT	CMOS push-pull output
7	—	OUTPUT	CMOS push-pull output
8	3	$V_{DD}$	Supply input, 4.5V to 18V

### 3.1 Supply Input ( $V_{DD}$ )

The  $V_{DD}$  input is the bias supply for the MOSFET driver and is rated for 4.5V to 18V with respect to the ground pins. The  $V_{DD}$  input should be bypassed to ground with a local ceramic capacitor. The value of the capacitor should be chosen based on the capacitive load that is being driven. A minimum value of 1.0  $\mu$ F is suggested.

### 3.2 Control Input

The MOSFET driver input is a high-impedance, TTL/CMOS-compatible input. The input circuitry of the TC4420/TC4429 MOSFET driver also has a “speed-up” capacitor. This helps to decrease the propagation delay times of the driver. Because of this, input signals with slow rising or falling edges should not be used as this can result in double-pulsing of the MOSFET driver output.

### 3.3 CMOS Push-Pull Output

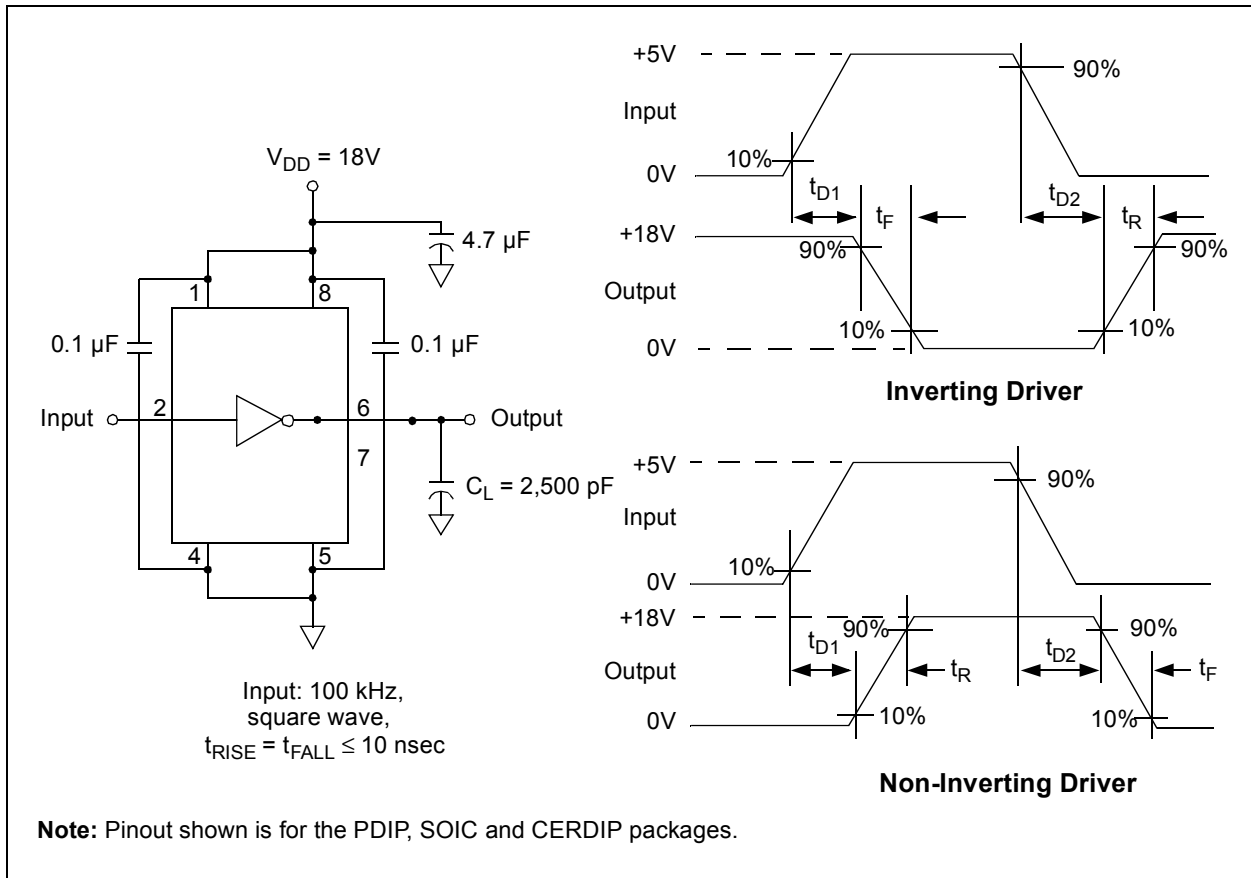
The MOSFET driver output is a low-impedance, CMOS, push-pull style output, capable of driving a capacitive load with 6.0A peak currents. The MOSFET driver output is capable of withstanding 1.5A peak reverse currents of either polarity.

### 3.4 Ground

The ground pins are the return path for the bias current and for the high peak currents that discharge the load capacitor. The ground pins should be tied into a ground plane or have very short traces to the bias supply source return.



## 4.0 APPLICATIONS INFORMATION



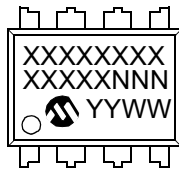
**FIGURE 4-1:** Switching Time Test Circuits.

# TC4420/TC4429

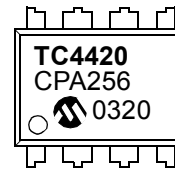
## 5.0 PACKAGING INFORMATION

### 5.1 Package Marking Information

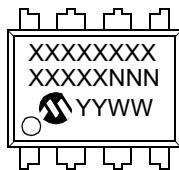
8-Lead PDIP (300 mil)



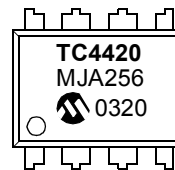
Example:



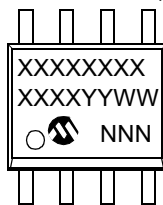
8-Lead CERDIP (300 mil)



Example:



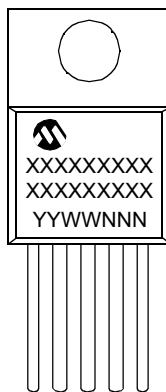
8-Lead SOIC (150 mil)



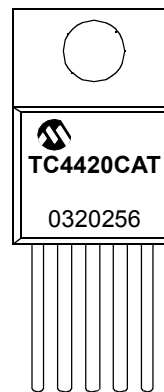
Example:



5-Lead TO-220



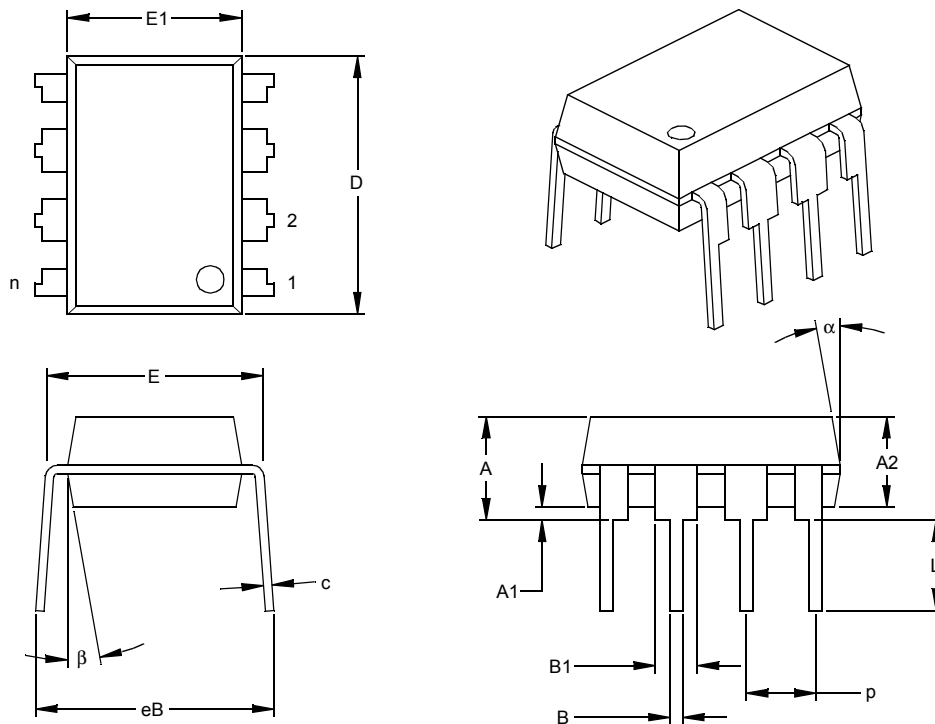
Example:



<b>Legend:</b>	XX...X	Customer specific information*
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
<b>Note:</b>	In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.	

\* Standard OTP marking consists of Microchip part number, year code, week code, and traceability code.

## 8-Lead Plastic Dual In-line (P) – 300 mil (PDIP)



Units		INCHES*			MILLIMETERS		
Dimension	Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8			8	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.140	.155	.170	3.56	3.94	4.32
Molded Package Thickness	A2	.115	.130	.145	2.92	3.30	3.68
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26
Molded Package Width	E1	.240	.250	.260	6.10	6.35	6.60
Overall Length	D	.360	.373	.385	9.14	9.46	9.78
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.045	.058	.070	1.14	1.46	1.78
Lower Lead Width	B	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing	§ eB	.310	.370	.430	7.87	9.40	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

\* Controlling Parameter

§ Significant Characteristic

### Notes:

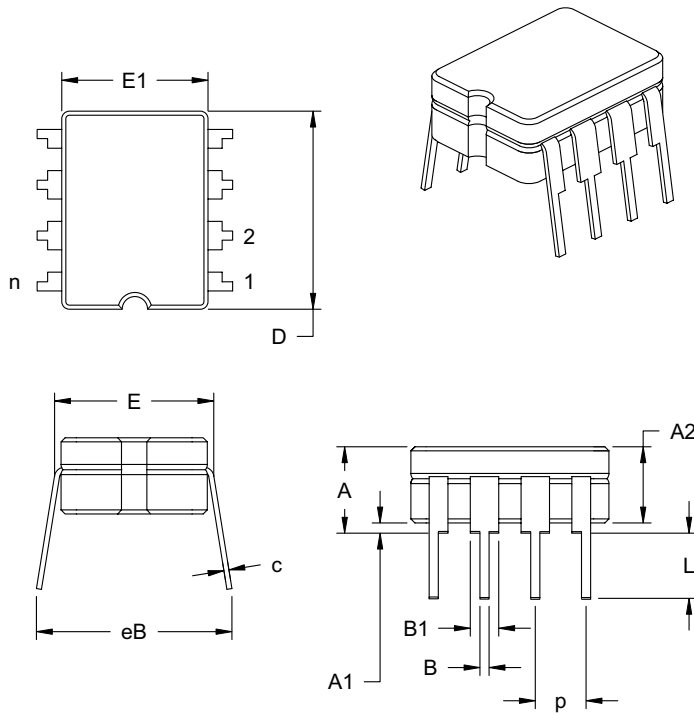
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-001

Drawing No. C04-018

# TC4420/TC4429

## 8-Lead Ceramic Dual In-line – 300 mil (CERDIP)



Units		INCHES*			MILLIMETERS		
Dimension Limits		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8			8	
Pitch	p		.100			2.54	
Top to Seating Plane	A	.160	.180	.200	4.06	4.57	5.08
Standoff §	A1	.020	.030	.040	0.51	0.77	1.02
Shoulder to Shoulder Width	E	.290	.305	.320	7.37	7.75	8.13
Ceramic Pkg. Width	E1	.230	.265	.300	5.84	6.73	7.62
Overall Length	D	.370	.385	.400	9.40	9.78	10.16
Tip to Seating Plane	L	.125	.163	.200	3.18	4.13	5.08
Lead Thickness	c	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.045	.055	.065	1.14	1.40	1.65
Lower Lead Width	B	.016	.018	.020	0.41	0.46	0.51
Overall Row Spacing	eB	.320	.360	.400	8.13	9.15	10.16

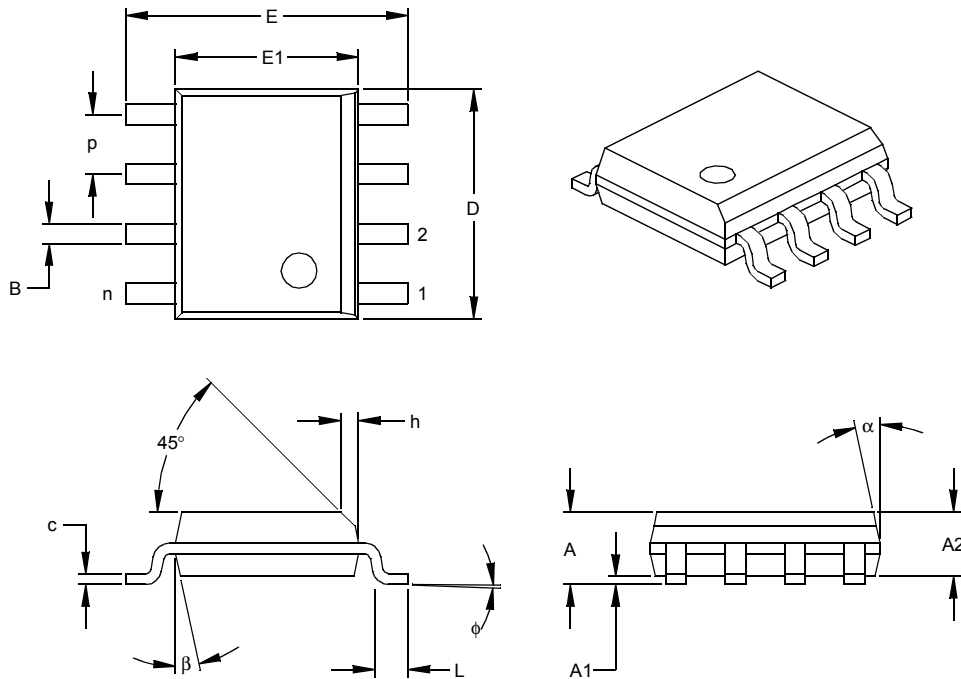
\*Controlling Parameter

JEDEC Equivalent: MS-030

Drawing No. C04-010

# TC4420/TC4429

## 8-Lead Plastic Small Outline (OA) – Narrow, 150 mil (SOIC)



Dimension Limits	Units	INCHES*			MILLIMETERS		
		MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8			8	
Pitch	p		.050			1.27	
Overall Height	A	.053	.061	.069	1.35	1.55	1.75
Molded Package Thickness	A2	.052	.056	.061	1.32	1.42	1.55
Standoff §	A1	.004	.007	.010	0.10	0.18	0.25
Overall Width	E	.228	.237	.244	5.79	6.02	6.20
Molded Package Width	E1	.146	.154	.157	3.71	3.91	3.99
Overall Length	D	.189	.193	.197	4.80	4.90	5.00
Chamfer Distance	h	.010	.015	.020	0.25	0.38	0.51
Foot Length	L	.019	.025	.030	0.48	0.62	0.76
Foot Angle	φ	0	4	8	0	4	8
Lead Thickness	c	.008	.009	.010	0.20	0.23	0.25
Lead Width	B	.013	.017	.020	0.33	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15

\* Controlling Parameter  
 § Significant Characteristic

**Notes:**

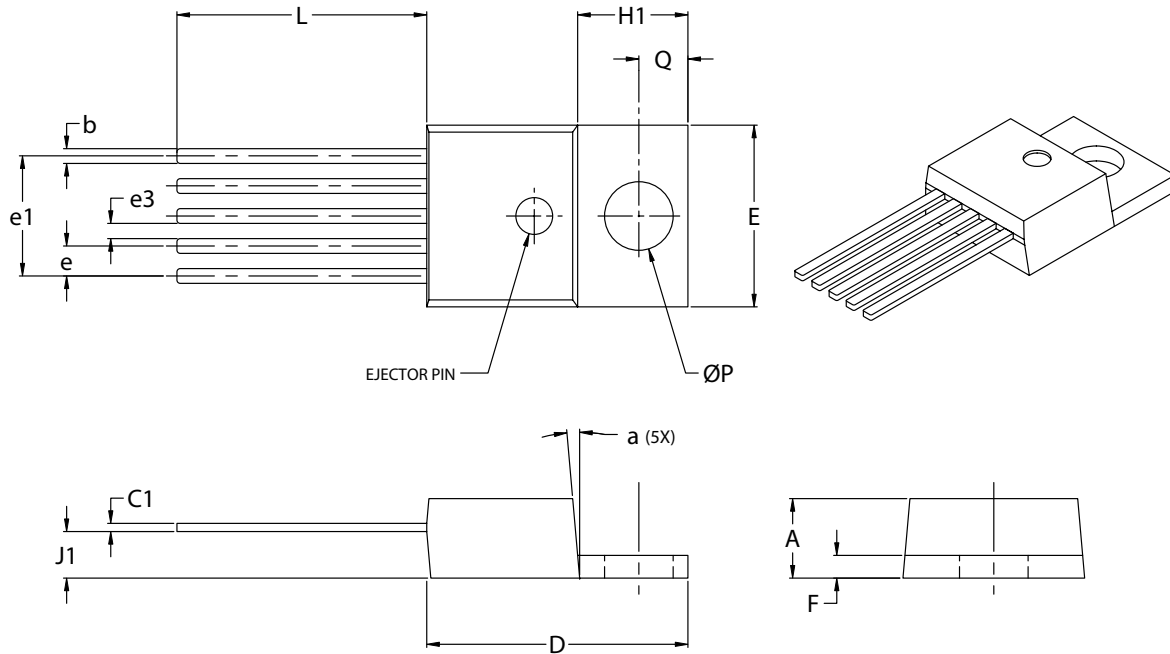
Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC Equivalent: MS-012

Drawing No. C04-057

# TC4420/TC4429

## 5-Lead TO-220



Dimension Limits	Units	INCHES*		MILLIMETERS	
		MIN	MAX	MIN	MAX
Lead Pitch	e	.060	.072	1.52	1.83
Overall Lead Centers	e1	.263	.273	6.68	6.93
Space Between Leads	e3	.030	.040	0.76	1.02
Overall Height	A	.160	.190	4.06	4.83
Overall Width	E	.385	.415	9.78	10.54
Overall Length	D	.560	.590	14.22	14.99
Flag Length	H1	.234	.258	5.94	6.55
Flag Thickness	F	.045	.055	1.14	1.40
Through Hole Center	Q	.103	.113	2.62	2.87
Through Hole Diameter	P	.146	.156	3.71	3.96
Lead Length	L	.540	.560	13.72	14.22
Base to Bottom of Lead	J1	.090	.115	2.29	2.92
Lead Thickness	C1	.014	.022	0.36	0.56
Lead Width	b	.025	.040	0.64	1.02
Mold Draft Angle	a	3°	7°	3°	7°

\*Controlling Parameter

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side.

JEDEC equivalent: TO-220

Drawing No. C04-036

## PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

<u>PART NO.</u>		<u>X</u>	<u>/XX</u>		
Device	Temperature Range		Package		
Device:	TC4420:	6A High-Speed MOSFET Driver, Non-Inverting			
	TC4429:	6A High-Speed MOSFET Driver, Inverting			
Temperature Range:	C =	0°C to +70°C			
	I =	-25°C to +85°C (CERDIP Only)			
	E =	-40°C to +85°C			
	V =	-40°C to +125°C			
	M =	-55°C to +125°C (CERDIP Only)			
Package:	AT =	TO-220, 5-lead			
	JA =	Ceramic Dual In-line (300 mil Body), 8-lead			
	PA =	Plastic DIP (300 mil Body), 8-lead			
	OA =	Plastic SOIC, (150 mil Body), 8-lead			
	OA713 =	Plastic SOIC, (150 mil Body), 8-lead Tape and Reel			
				<b>Examples:</b>	
				a) TC4420CAT:	6A High-Speed MOSFET Driver, Non-inverting, TO-220 package, 0°C to +70°C.
				b) TC4420JA:	6A High-Speed MOSFET Driver, Non-inverting, CERDIP package, -25°C to +85°C.
				c) TC4420EOA:	6A High-Speed MOSFET Driver, Non-inverting, SOIC package, -40°C to +85°C.
				d) TC4420VAT:	6A High-Speed MOSFET Driver, Non-inverting, TO-220 package, -40°C to +125°C.
				e) TC4420MJA:	6A High-Speed MOSFET Driver, Non-inverting, CERDIP package, -55°C to +125°C
				a) TC4429CAT:	A High-Speed MOSFET Driver, Inverting, TO-220 package, 0°C to +70°C
				b) TC4429JA:	A High-Speed MOSFET Driver, Inverting, CERDIP package, -25°C to +85°C
				c) TC4429EPA:	A High-Speed MOSFET Driver, Inverting, PDIP package, -40°C to +85°C
				d) TC4429VAT:	A High-Speed MOSFET Driver, Inverting, TO-220 package, -40°C to +125°C
				e) TC4429MJA:	A High-Speed MOSFET Driver, Inverting, CERDIP package, -55°C to +125°C

## Sales and Support

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Products supported by a preliminary Data Sheet may have an errata sheet describing minor operational differences and recommended workarounds. To determine if an errata sheet exists for a particular device, please contact one of the following:

1. Your local Microchip sales office
2. The Microchip Corporate Literature Center U.S. FAX: (480) 792-7277
3. The Microchip Worldwide Site ([www.microchip.com](http://www.microchip.com))

Please specify which device, revision of silicon and Data Sheet (include Literature #) you are using.

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# TC4420/TC4429

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NOTES:



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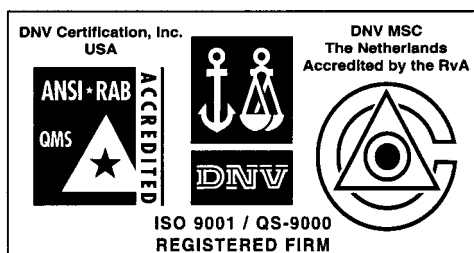
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